

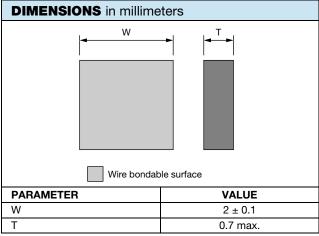
www.vishay.com

## Vishay BCcomponents

# **Leadless NTC Thermistor Die Suitable for Wire Bonding**



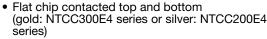
QUICK REFERENCE DATA					
PARAMETER	VALUE	UNIT			
Resistance value at 25 °C	4.7K to 20K	Ω			
Tolerance on R <sub>25</sub> -value	± 1 to ± 5	%			
B <sub>25/85</sub> -value	3435 to 3865	K			
Tolerance on B <sub>25/85</sub> -value	± 1	%			
Operating temperature range	-55 to +175	°C			
Response time (63.2 %) 25 °C to 85 °C still air (for info)	3	S			
Dissipation factor $\delta$ in still air (for info, non-mounted die)	3	mW			
Maximum power dissipation	50	mW			
Weight	3	mg			



#### Note

 Non-dimensioned details do not affect the performance of the thermistors.

#### **FEATURES**





- Wide temperature range from -55 °C to +175 °C
- · Highly resistant to thermal shocks
- Ideal for wire bonding (aluminum or gold depending on metallization type)
- RoHS

- · Resistance to leaching
- Delivered on blister tape
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- High temperature sensing, control and compensation.
   E.g. IGBT modules (inverters in EV and HEV vehicles)
- IC and semiconductor protecting
- DC/AC power inverters and HIC overheat protecting

#### **MOUNTING**

The thermistors are primarily intended for wire bonding. The parameters of the assembly process should be chosen in accordance with the lead-wire material.

The mounting process should be in compliance with the following guidelines and recommendations:

#### Die bonding:

- · Gold electrode: silver epoxy gluing.
- Silver electrode: (vacuum) reflow soldering silver epoxy gluing - nano silver sintering.

#### Cleaning:

- Detergent spraying.
- · Ultrasonic cleaning is not recommended.

#### Wire bonding:

- The gold electrode has been tested for gold wire bonding with a wire diameter of max. 32 µm.
- The silver electrode has been tested for aluminium wire bonding with a wire diameter of max. 300 µm.

#### **Encapsulation:**

- In order to preserve the characteristics of the bonded die at long term an encapsulation is mandatory.
- The encapsulation is defined by the user. Silicon and epoxy encapsulations have been tested. For recommendations on compatible encapsulants contact Vishay.

Document Number: 29153

ELECTRICAL DATA AND ORDERING INFORMATION							
VISHAY SAP ORDERING NUMBER (1)	$R_{25}$ -VALUE (kΩ)	ΔR <sub>25</sub> -VALUE (%)	B <sub>25/85</sub> -VALUE (K)	B <sub>25/85</sub> -TOL. (%)	DESCRIPTION		
NTCC200E4472*T	4.7	1, 2, 3, 5	3435	1	Bare die with top /bottom silver terminations		
NTCC200E4123*T	12	1, 2, 3, 5	3740	1	Bare die with top /bottom silver terminations		
NTCC200E4203*T	20	1, 2, 3, 5	3865	1	Bare die with top /bottom silver terminations		
NTCC300E4472*T	4.7	1, 2, 3, 5	3435	1	Bare die with top /bottom gold terminations		
NTCC300E4123*T	12	1, 2, 3, 5	3740	1	Bare die with top /bottom gold terminations		
NTCC300E4203*T	20	1, 2, 3, 5	3865	1	Bare die with top /bottom gold terminations		

#### Note

Revision: 10-Oct-14

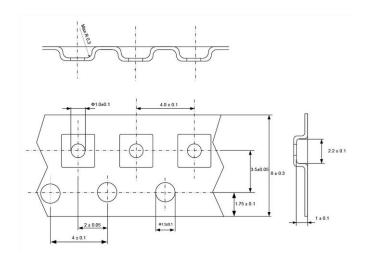
(1) In order to define  $R_{25}$ -tolerance, replace \* in SAP part number by F (± 1 %), G (± 2 %), H (± 3 %) of J (± 5 %).



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## **PACKAGING INFORMATION**

The components are delivered on 8mm embossed blister tape (conductive PS) conforming to EIA-481 and IEC 60286-3, with 2000 parts per reel.





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Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

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